In partnership with ST Microlectronics Rousset (EWS Probe card Group) Synergie Cad Probe developed a concept to improve probe mark quality and reduce cost of wafer level test High parallellis m For all Very fine High pin pitch/pad size technologies count Vertical on new product Cantilever Mems **ST Microelectronics DIAMETER Our Need is** certification of X/Y alignment in production Quick test time Data collection

STMicroelectronics

Ews Rousset/Probe card Groupe/R. Diperi- D. Baumann

SAMX.9®







Accepted Solution



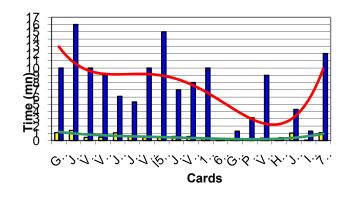
- Test of Probe Alignment (X/Y)
- **❖** Test of Probe Diameter
- Precise and Repetitive Measurements
- **❖** Speed of Setup (≈ 1 minute)
- **♦** Short Test Time (1000 probes ≈ 3 minutes)
- ❖ Easy to Handle
- Operator Friendly (Touch-Screen with Windows 7®)
- Test of all Probe Card Technologies
- **❖** Tested and Approved by Major Semiconductor Fabs
- Competitive cost, One Year Return on Investment

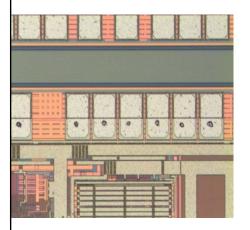
Ews Rousset/Probe card Groupe/R. Diperi- D. Baumann



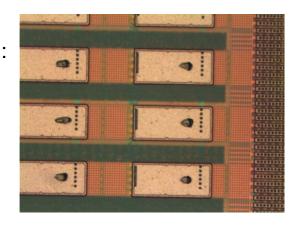
CAPITAL GAIN IN PRODUCTION

- Cell test Up time improvement
 - Setup optimization/start efficiency
 - Setup time reduction
 - Low MMTR probe card
 - Diagnostic less than 5'





- Quality improvement
 - Check all probe cards before use :
 - Probe mark position and integrity



STMicroelectronics

Ews Rousset/Probe card Groupe/R. Diperi- D. Baumann

Your Contacts





Didier Baumann: didier.baumann@st.com

Robert Diperi: robert.diperi@st.com



info@synergie-cad-probe.fr



sales@jpkummer.fr